

April 1988 Revised October 2000

## 74F821

# 10-Bit D-Type Flip-Flop

#### **General Description**

#### **Features**

The 74F821 is a 10-bit D-type flip-flop with 3-STATE true outputs arranged in a broadside pinout.

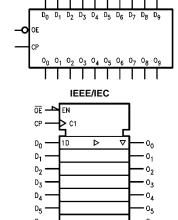
■ 3-STATE Outputs

## **Ordering Code:**

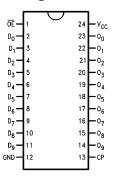
	Order Number	Package Number	Package Description					
74F821SC M24B		M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide					
74F821SPC N24C		N24C	24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide					

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

#### **Logic Symbols**



#### **Connection Diagram**



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DS009595

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## **Unit Loading/Fan Out**

Din Names	Decerinties	U.L.	Input I <sub>IH</sub> /I <sub>IL</sub>		
Pin Names	Description	HIGH/LOW	Output I <sub>OH</sub> /I <sub>OL</sub>		
D <sub>0</sub> -D <sub>9</sub> OE	Data Inputs	1.0/1.0	20 μA/-0.6 mA		
ŌĒ	Output Enable	1.0/1.0	20 μA/-0.6 mA		
	3-STATE Input				
CP	Clock Input	1.0/1.0	20 μA/–0.6 mA		
O <sub>0</sub> -O <sub>9</sub>	3-STATE Outputs	150/40 (33.3)	-3.0 mA/24 mA (20 mA)		

#### **Functional Description**

The 74F821 consists of ten D-type edge-triggered flipflops. This device has 3-STATE true outputs for bus systems organized in a broadside pinning. The buffered Clock (CP) and buffered Output Enable (OE) are common to all flip-flops. The flip-flops will store the state of their individual D inputs that meet the setup and hold times requirements on the LOW-to-HIGH CP transition. With the  $\overline{\text{OE}}$  LOW the content of the flip-flops are available at the outputs. When the  $\overline{OE}$  is HIGH, the outputs go to the high impedance state. Operation of the  $\overline{OE}$  input does not affect the state of the flip-flops.

#### **Function Table**

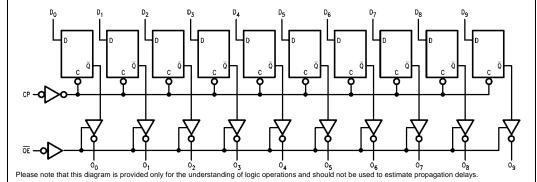
Inputs			Internal	Output	Function			
OE	СР	D	Q	0	Function			
Н	Н	Χ	NC	Z	Hold			
Н	L	Χ	NC	Z	Hold			
Н	_	L	Н	Z	Load			
Н	_	Н	L	Z	Load			
L	_	L	Н	L	Data Available			
L	_	Н	L	Н	Data Available			
L	Н	Х	NC	NC	No Change in Data			
L	L	Χ	NC	NC	No Change in Data			

- L = LOW Voltage Level
- H = HIGH Voltage Level

- X = Immaterial
  Z = High Impedance

  ✓ = LOW-to-HIGH Transition NC = No Change

# **Logic Diagram**



## **Absolute Maximum Ratings**(Note 1)

Storage Temperature -65°C to +150°C Ambient Temperature under Bias -55°C to +125°C

Junction Temperature under Bias -55°C to +150°C V<sub>CC</sub> Pin Potential to Ground Pin -0.5V to +7.0V

Input Voltage (Note 2) -0.5V to +7.0VInput Current (Note 2)  $-30\ \text{mA}$  to  $+5.0\ \text{mA}$ 

Voltage Applied to Output

in HIGH State (with  $V_{CC} = 0V$ )

Standard Output -0.5V to  $V_{CC}$ 3-STATE Output -0.5V to +5.5V

Current Applied to Output

twice the rated  $I_{OL}$  (mA) in LOW State (Max)

#### **Recommended Operating Conditions**

Free Air Ambient Temperature 0°C to +70°C Supply Voltage +4.5V to +5.5V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

#### **DC Electrical Characteristics**

Symbol	Parameter		Min	Тур	Max	Units	V <sub>CC</sub>	Conditions
V <sub>IH</sub>	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal
V <sub>IL</sub>	Input LOW Voltage				0.8	V		Recognized as a LOW Signal
V <sub>CD</sub>	Input Clamp Diode Voltage				-1.2	V	Min	I <sub>IN</sub> = -18 mA
V <sub>OH</sub>	Output HIGH	10% V <sub>CC</sub>	2.5					I <sub>OH</sub> = -1 mA
	Voltage	10% V <sub>CC</sub>	2.4			V	Min	$I_{OH} = -3 \text{ mA}$
		$5\% V_{CC}$	2.7			V	IVIIII	$I_{OH} = -1 \text{ mA}$
		5% V <sub>CC</sub>	2.7					$I_{OH} = -3 \text{ mA}$
V <sub>OL</sub>	Output LOW Voltage	10% V <sub>CC</sub>			0.5	V	Min	I <sub>OL</sub> = 24 mA
I <sub>IH</sub>	Input HIGH Current				5.0	μА	Max	V <sub>IN</sub> = 2.7V
I <sub>BVI</sub>	Input HIGH Current				7.0		May	V 7.0V
	Breakdown Test				7.0	μΑ	Max	V <sub>IN</sub> = 7.0V
I <sub>CEX</sub>	Output HIGH Leakage Current				50	μА	Max	V <sub>OUT</sub> = V <sub>CC</sub>
					30	μΛ	IVIAX	VOUT - VCC
V <sub>ID</sub>	Input Leakage		4.75			V	0.0	$I_{ID} = 1.9 \mu A,$
	Test	4.75			v	0.0	All Other Pins Grounded	
I <sub>OD</sub>	Output Leakage				3.75	μА	0.0	V <sub>IOD</sub> = 150 mV
	Circuit Current				3.73	μΛ	0.0	All Other Pins Grounded
I <sub>IL</sub>	Input LOW Current				-0.6	mA	Max	V <sub>IN</sub> = 0.5V
I <sub>OZH</sub>	Output Leakage Current				50	μА	Max	V <sub>OUT</sub> = 2.7V
I <sub>OZL</sub>	Output Leakage Current				-50	μΑ	Max	V <sub>OUT</sub> = 0.5V
los	Output Short-Circuit Current		-60		-150	mA	Max	V <sub>OUT</sub> = 0V
I <sub>CCZ</sub>	Power Supply Current			78	100	mA	Max	V <sub>O</sub> = HIGH Z

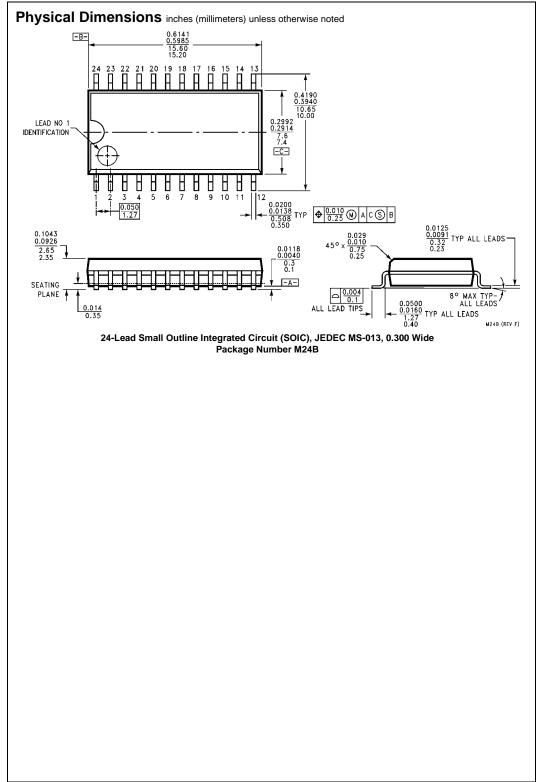
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## **AC Electrical Characteristics**

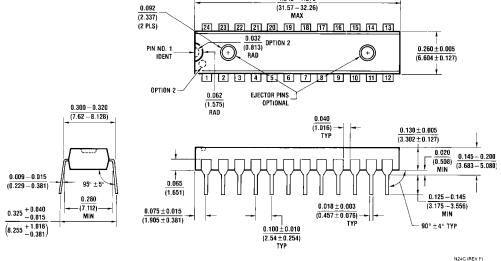
Symbol	Parameter	$T_{A} = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_{L} = 50 \text{ pF}$			$T_A = -55^{\circ}C \text{ to } +125^{\circ}C$ $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$		$T_A = 0$ °C to $+70$ °C $V_{CC} = +5.0V$ $C_L = 50$ pF		Units	
		Min	Тур	Max	Min	Max	Min	Max		
f <sub>MAX</sub>	Maximum Clock Frequency	100	150		60		70		MHz	
t <sub>PLH</sub>	Propagation Delay	2.0	6.4	9.5	2.0	10.5	2.0	10.5		
t <sub>PHL</sub>	CP to O <sub>n</sub>	2.0	6.2	9.5	2.0	10.5	2.0	10.5	ns	
t <sub>PZH</sub>	Output Enable Time	2.0	5.8	10.5	2.0	13.0	2.0	11.5		
$t_{PZL}$	OE to O <sub>n</sub>	2.0	6.3	10.5	2.0	13.0	2.0	11.5		
t <sub>PHZ</sub>	Output Disable Time	1.5	3.4	7.0	1.0	7.5	1.5	7.5	ns	
$t_{PLZ}$	OE to O <sub>n</sub>	1.5	3.5	7.0	1.0	7.5	1.5	7.5		

## **AC Operating Requirements**

		$T_A = +25$ °C $V_{CC} = +5.0V$		$T_A = -55$ °C to +125°C $V_{CC} = +5.0V$		$T_A = 0$ °C to +70°C $V_{CC} = +5.0V$		Units	
Symbol	Parameter								
		Min	Max	Min	Max	Min	Max		
t <sub>S</sub> (H)	Setup Time, HIGH or LOW	2.5		4.0		3.0			
t <sub>S</sub> (L)	D <sub>n</sub> to CP	2.5		4.0		3.0		ns	
t <sub>H</sub> (H)	Hold Time, HIGH or LOW	2.5		2.5		2.5		115	
t <sub>H</sub> (L)	D <sub>n</sub> to CP	2.5		2.5		2.5			
t <sub>W</sub> (H)	CP Pulse Width	5.0		6.0		6.0		ns	
t <sub>W</sub> (L)	HIGH or LOW	5.0		6.0		6.0		115	



# Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N24C

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